



ASSIGNMENT

WHEREAS **We, Jin Woong HA of D-403, Dongyang Greenauseu, 296, Bongmyeong-dong, Cheonan-si, Chungcheongnam-do 330-930, Republic of Korea, Jeeho KIM of 702-1802, Yeolmaemaetul 7-danjl Hyundai Apt., Jijok-dong, Yuseong-gu, Daejeon 305-770, Republic of Korea, HanHo LEE of 103-204, Hyundai Apt., 431-6, Doryong-dong, Yuseong-gu, Daejeon 305-340, Republic of Korea** (hereinafter referred to as "ASSIGNORS") are the owner of the entire right, title and interest in the following United States Patent Application:

Serial No. **11/317,433**, filed on **December 23, 2005**, entitled **HEAT RADIATION STRUCTURE FOR SECONDARY BATTERY MODULE, AND SWITCHING BOARD AND SECONDARY BATTERY MODULE HAVING THE SAME**

WHEREAS, **LG CHEM, LTD.** (hereinafter referred to as "ASSIGNEE"), a corporation organized and existing under the laws of the Country of Republic of Korea having a place of business at **20, Yoido-dong, Youngdungpo-gu, Seoul 150-721, Republic of Korea** is desirous of acquiring an interest in the United States and all foreign countries, in and to the said invention and Letters Patent to be obtained therefor;

NOW THEREFORE, TO ALL WHOM IT MAY CONCERN, be it known that, for good and valuable consideration, the receipt of which is hereby acknowledged, We, the said ASSIGNORS have assigned and transferred, and hereby assign and transfer unto the said ASSIGNEE, the entire right, title and interest in and to said invention in the United States and in all foreign countries, including priority rights, as fully set forth and described in said application; and We do hereby authorize and request the Commissioner of Patents to issue said Letters Patent on said application, and any and all Letters Patent that may be issued upon any and all revivals, re filings, continuations, continuations-in-part, divisions and reissues thereof, to the said ASSIGNEE, an assignee of the entire right, title and interest in and to the same, for the sole use and behoof of ASSIGNEE, its successors and assigns; and We do hereby agree that the



said ASSIGNEE, may apply for foreign Letters Patent on said invention and that We will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by the said ASSIGNEE, its successors or assigns, and that We will, at the cost and expense of the said ASSIGNEE fully assist and cooperate in all matters in connection with the United States and foreign applications and patents issuing thereon.

The undersigned declare that all statements made herein of their own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Date: 19/01/2006

Jin Woong HA L.S.  
Jin Woong HA

Date: 19/01/2006

Jeeho KIM L.S.  
Jeeho KIM

Date: 19/01/2006

HanHo LEE L.S.  
HanHo LEE

